

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| S107 | 2 | "6159826".pn. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/01 15:46 |
| L2 | 1492 | bond near10 probe and semiconductor | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/08 19:42 |
| L1 | 4387 | bond near10 probe | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/08 19:42 |
| L4 | 25 | gerald near2 friese.in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/08 19:43 |
| L3 | 785 | bond near10 probe near10 pad and semiconductor | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/08 19:43 |
| S66 | 52 | barrier near2 layer near5 (titanium ti tin) near5 (tantalum or tan or ta) near5 (copper and aluminum) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/08 19:45 |
| S5 | 56 | bond\$3 near2 pad same probe same barrier | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/12/08 19:45 |